Evolving mud-crack patterns

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In mud, crack patterns are frequently seen with either an approximately rectilinear or hexagonal tiling. Here we show, experimentally, how a desiccation crack pattern changes from being dominated by 90° joint angles, to 120° joint angles. Layers of bentonite clay, a few mm thick, were repeatedly wetted and dried. When dried, the layers crack. These cracks visibly close when rewetted, but a similar crack pattern forms when the layer is re-dried, with cracks forming along the lines of previously open cracks. Time-lapse photography was used to show how the sequence in which individual cracks open is different in each generation of drying. The geometry of the crack pattern was observed after each of 25 generations of wetting and drying. The angles between cracks were found to approach 120°, with a relaxation time of approximately 4 generations. This was accompanied by a gradual change in the position of the crack vertices, as the crack pattern evolved. A simple model of crack behavior in a layer where the positions of previously open cracks define lines of weakness is developed to explain these observations.

I. INTRODUCTION

When slurries dry, they tend to crack. These cracks form sequentially, and when a later, or secondary, crack approaches an earlier, or primary, one it curves to intersect it at 90°, forming a ‘T-junction’. The resulting crack pattern divides the dried layer into roughly rectilinear pieces, such as those shown in Fig. 1(a,b). This behavior has been reported in many materials, including clay [1, 2], colloidal alumina [3], corn-starch [4–6], and coffee grounds [7]. The patterns found in dried mud are, however, not always as suggested by these experiments. Mud can, as shown in Fig. 1 (c,d), contain crack networks that outline roughly hexagonal cells, with cracks intersecting at 120°, forming ‘Y-junctions’. The origin of these differences in geometry is not understood.

In this paper, we consider the cracks that form when clay dries. We describe how the junctions between cracks can evolve when the layer is repeatedly wetted and dried, and show how a rectilinear crack pattern changes into a hexagonal crack pattern. These observations are explained using a simple model of crack formation, where the positions of previously open cracks influence the development of the next generation of cracking.

II. MATERIALS AND METHODS

Slurries of bentonite clay (Acros Organics, Bentonite K-10) and de-ionized water were prepared by adding water to dry bentonite powder until it could be easily stirred. Slightly less than two parts of water were added for every part bentonite, by mass. These slurries were poured into flat-bottomed polystyrene petri-dishes (150 mm diameter, 10 mm height). At the end of each experiment, the thickness of the clay layers was measured by picking up several dried pieces, and measuring their thickness with micro-calipers.

Dishes were placed approximately 50 cm below a pair of 150 W halogen heat lamps, and allowed to dry, and crack, over a period of two to three days. The clay remained gently bound to the bases of the dishes, and could be rewetted by gently spraying the surface with a fine mist of deionized water, using a spray bottle held approximately 30 cm away from the clay surface. Water was added until the cracks in the center of the dish were seen to visibly close; 1 to 1.2 times the dried slurry mass

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of water was added.

Digital images of the clay surface were taken after each generation of drying. In some cases additional time-lapse images were taken throughout the course of drying. Permanent marks were made on the outside of each dish, which were used to align images in different generations. Typically these markers could be realigned to within one or two pixels, or an error of 0.1 mm. The geometries of the resulting crack patterns were measured in these images. For most measurements the dominant error was due to sample size: there were large standard deviations in the observables, and each data set had approximately one hundred measurements. To avoid edge effects all cells either adjacent to, or one cell removed from, the walls of the dish were ignored. For layers thicker than 7 mm this did not leave enough remaining cells to report significant data. When studying the evolution of patterns over multiple generations, data were averaged over four separate dishes, in order to minimize statistical errors.

III. RESULTS

A. Crack formation

When a dried clay layer was dried, rewetted, and then stirred to homogenize the slurry, the crack pattern in the next generation had no relation to the original pattern. Similarly, in layers that were rewetted until the clay was submerged, the subsequent crack pattern was largely unrelated to the original. Some similarities could be seen between generations, particularly in thicker layers, but most crack positions changed. If the clay was rewetted to the point where the cracks visibly closed, but the surface was not submerged, the crack pattern in the redried clay closely matched the pattern in the initially dried clay. However, this persistence was dependent on the layer thickness. For the thinnest layers, approximately 1 mm thick, rewetting the dried clay with a fine mist changed the positions of most cracks.

Time-lapse photos were taken every 5 minutes of a 2.9±0.1 mm thick drying clay layer, during the first 3 generations. In the first generation most cracks appeared between images. When cracks met, they formed T-junctions, as a later crack will preferentially meet an earlier one in a normal direction [5]. The cracks showed clear, well-defined edges, and the surface of the clay was smooth. After rewetting, cracks in later generations opened more slowly, often through the coalescence of several smaller cracks opening along some previous crack, and their faces become more uneven and jagged. Opening could take several minutes to occur, as observed in a few sequential images. After the first generation, the cracks formed shallow depressions in their vicinity, which remained visible in the rewetted layers. These depressions were less than a mm deep, but imply that the clay is of order 10% thinner in the vicinity of a previously open crack. The surface of the clay become rougher in later generations, but this was likely a result of the methods of rewetting the clay, which involved misting the surface with droplets of water. The changes in surface and crack roughness can be seen in Fig. 2.

In each generation the pattern of cracks and vertices was similar, but the sequence in which cracks appeared was different. At any vertex there are three directions along which there are cracks. In each generation, at each vertex, one of these three cracks will open last. This choice was measured at all 243 vertices within an area, in the first and second generations of drying. At 159 vertices the sequence in which cracks appeared was the same in both generations. At 62 vertices, however, the sequence was different. In these cases, in the second generation, the crack approaching the vertex at approximately 90° to its neighbors opened first, or second, rather than last. At the remaining 22 vertices, the sequence could not be determined. Thus, between 26% and 35% of the vertices formed through sequences of crack openings that were different in the first and second generations. If the uncertain vertices are assumed to be distributed with the same probabilities as the measured vertices, this percentage is estimated to be 28%.

B. Crack spacing

Twenty-five dishes were prepared, each containing a clay slurry of different thickness. When dried, the resulting clay layers were between 1 and 7 mm thick. In most cases, the clay cracked into a network where each crack ended either on another crack, or on the walls of the dish. These connected networks of cracks formed a tiling of the clay surface. For layers thinner than approximately 1.5 mm, the cracks instead formed a disconnected network, where most cracks came to an end without intersecting another crack.

The average crack spacing was measured in two ways. First, the cross-sectional areas A fully enclosed by cracks were measured, and the crack spacing was taken to be \(\sqrt{A}\). Second, the crack spacing was measured by randomly placing a line across a thresholded image of the crack pattern, and automatically detecting the distance between intersections of the line, and cracks. By averag-
FIG. 3: The spacing of desiccation cracks in bentonite clay increases as the thickness of the cracking layer increases. For thin layers with unconnected cracks the crack spacing appears to be larger than expected from a simple proportional relationship.

FIG. 4: The pattern of cracks changes slowly after many cycles of wetting and drying. The initial pattern (a) is dominated by cracks meeting at 90° and 180°. Through generations (b) 3, (c) 5, (d) 10, (e) 15, and (f) 25, the pattern slowly changes to one with many joints closer to 120° angles. Each panel shows a 6×6 cm² area at the centre of a dried bentonite slurry.

FIG. 5: The average cross-sectional area of clay cells increases slightly in the first 5 generations, as some cracks will not be open in any particular generation. However, histograms of the distributions of cell areas do not show any other substantial differences between the 1st and 25th generations. Representative error bars are shown for Generation 1.

C. Pattern dynamics

The evolution of the crack pattern was observed in four clay samples, each 3.1±0.3 mm thick, over twenty-five consecutive re-wettings, or generations. Layers of this thickness formed clearly observable crack patterns with over a hundred cells of dried clay, and could be rewetted without damaging the pattern. As can be seen in Fig. 4, all cracks in the pattern throughout these 25 generations can be identified in the original pattern. However, the fine details of the pattern are different in each generation. This is highlighted in Fig. 2, which shows how two crack vertices were modified through the first four generations.

Over multiple rewettings, the average area of the polygonal cells composing the dried crack patterns increased with time. In particular, the mean area increased by 20% within the first 5 generations, and retained this elevated value throughout the next 20 generations. This effect is due to the failure of some cracks to open in certain generations. It was not uncommon for a crack to be missing in one particular drying, only to reappear, in approximately its original place, in a later generation. Some cracks were seen to reappear up to ten generations after they had vanished, in this manner. When a crack vanishes, two adjacent cells merge into one, increasing the average area of the pattern. The distribution of areas does not otherwise change substantially between generations, as shown in Fig. 5. The standard deviation divided by the mean of the cell area, which describes the relative width of the area distribution, may decrease slightly over time, but this decrease is at most 10% over 25 generations.

In contrast to the relatively small changes in cell area, the angles between cracks at a vertex evolve rapidly, in these experiments. These joint angles were measured di-
rectly from digital images, taking care to measure the crack directions as near the vertex as possible. Initially, as shown in Fig. 6, most vertices contain cracks at 90° and 180° to each other. In subsequent rewettings, this distribution of angles shifts, and the two peaks of the distribution of angles approach each other. After only 10 generations, the distribution is broadly centered around a single peak at 120°, as shown in Fig. 6.

As joint angles change, it can become difficult to distinguish between T-junctions and Y-junctions. Since the average angle of three cracks meeting at a vertex is always 120°, the standard deviation was instead used to characterize the relaxation of joint angles \( \theta \). The standard deviation decreases consistently throughout the first ten generations, after which time it ceases to change noticeably. A final value of \( \sigma_o = 24.9 \pm 0.5° \) describes generations 15 through 25. The timescale over which the angles relaxed was measured by fitting an exponential decay to the evolution of \( \sigma \), as shown in Fig. 7. A decay time of 4.2±0.5 generations was found.

As the cracks around a vertex change, the vertex also moves. Absolute changes in vertex positions were measured by comparing images of crack patterns in different generations. As shown in Fig. 8(a), there is a substantial change in the vertex positions between the first and second generations, followed by a more gradual, but continuous, motion. In these experiments, there is an average movement of each vertex, between generations 2 and 25, of 30 μm per generation. It is interesting to note that this motion continues after the crack angles have stabilized. This suggests that there may be dynamics that continue well past the 25 generations observed in this study. After 25 generations, vertices had shifted their positions, on average, by slightly more than 1 mm, or approximately 10% of the average fracture spacing.

The motion of a vertex has a weak tendency to be normal to the original primary crack. In each experiment, a single primary crack was chosen. This crack opened early enough in the first generation so that all adjoining cracks intersect it at right angles. The position of the vertices along this crack were compared before and after 25 cycles of wetting and drying. In each of the four dishes, 70±10% of the vertices were observed to move in a direction on the same side of the crack approaching the vertex at right angles. This is demonstrated in Fig. 8(b).
IV. DISCUSSION

The experiments presented here show that crack patterns in clay evolve when the clay is repeatedly wetted and dried. Over approximately ten generations, the average angle between adjacent cracks was observed to approach to 120°. This relaxation was accompanied by a gradual movement of the vertices of the crack pattern, which continued up to at least the twenty-fifth generation. Where three cracks met at a T-junction, this motion tended to shorten the crack that had originally approached a straight crack at two right angles.

Here, we argue that the evolution of crack patterns from rectilinear T-junctions towards hexagonal Y-junctions follows from three aspects of crack behavior. First, that it is easier to crack along the path of a previously open crack. Second, that a crack will advance in a way to relieve the most local strain energy possible, whilst minimizing the energy cost in creating new crack faces. Finally, that each time the layer cracks, the sequence of crack opening may be different.

The crack patterns reported here show a long-term persistence in the position of cracks, coupled with gradual pattern dynamics. Information about crack positions must be stored in the clay layer, across multiple wettings and dryings. A similar concept was demonstrated by Nakahara and Matsuo [8], who vibrated slurries prior to drying them. The resulting cracks were largely co-aligned with the direction of vibration. There are, however, more concrete features in our experiments that could also lead to the persistence of the crack positions. The cracks may not heal completely, especially at depth, as the clay is not completely resaturated. Under such conditions, the positions of previous cracks would be weaker than the surrounding clay. Also, the shallow depressions that form around cracks cause the layer thickness to be thinner near old crack locations. Opening a crack in an area which is weakened or thinned by a partially healed crack requires less work.

A rectilinear crack pattern provides information regarding the sequence in which cracks formed [5]. However, this sequence differs across generations. When a crack approaches the position of a vertex, prior to the opening of any other cracks in the vicinity, there is a choice presented. The crack can halt at the vertex, it can continue to propagate down one, or the other, leg of the vertex, or it can split and propagate down both remaining legs of the vertex.

Consider the case where a propagating crack changes direction near the position of a vertex from the previous generation. Perhaps it approaches along what had been the ‘secondary’ crack, and continues along the path of one of the ‘primary’ cracks. The crack will tend to open in a way to maximize the difference between the strain energy released, and the fracture energy spent [9]. As the crack approaches the vertex, the total crack length will be less if it curves around the vertex, rather than kinking. By bending, however, the crack will go through stiffer material. The total fracture energy will therefore represent a balance between these effects. When the saving in energy is sufficient, the crack should round the vertex, as sketched in Fig. 2.

If a single change in the sequence of crack formation were to modify a T-junction into a Y-junction, and this sequence has a probability $p$ of changing in each generation, then the number of T-junctions in the crack pattern would decrease exponentially, with a fraction

$$n_T = (1 - p)^m = e^{-m/\tau}$$

remaining in generation $m + 1$. In the experiments presented here, between the first two generations, it was found that $p = 0.28 \pm 0.04$. Under these conditions, one would expect a decay time of $\tau = -1/\ln(0.72) = 3.0 \pm 0.5$ generations. Indeed, the observed distributions of joint angles appear to relax exponentially, as was shown in Fig. 7, with a decay time of $4.2 \pm 0.6$ generations. This generally agrees with, but is slightly slower than, the prediction just made. It should be noted that it may take more than one change in crack sequence to fully adjust the vertex and relax the joint angles.

After many generations, a Y-junction should be stable to random changes in the sequence of crack formation. If each crack path opens first with equal frequency, then there is no average tendency for the vertex of a Y-junction to move in any direction. It is likely that this state was not fully reached in this experiment, as we were still observing directed changes in the vertex positions in generation 25. This suggests that there may be ad-
ditional interesting long-term evolution to a mud-crack pattern, including, for example, a more gradual narrowing of the cell area or joint angle distribution.

In an outdoor setting, cycles in the weather cause soil to be repeatedly wetted and dried, providing the conditions for mud cracks to evolve towards $120^\circ$ joint angles. This environment is unlikely to be as controlled, or gentle, as our rewetting procedure. In compensation, the crack patterns in some soils may be more persistent than these experiments suggest. The hexagonal pattern shown in Fig. 1(c) is of Racetrack Playa, in Death Valley, which is periodically inundated with water. Similarly, areas near the pattern shown in Fig. 1(d) were visibly submerged, yet hexagonal.

The experimental conditions used in this study are also somewhat analogous to those of polygonal terrain, which forms in repeatedly frozen, and thawed soils. There, each annual thermal cycle contains one generation of fracture [10, 11]. Over many such cycles, it is thought that an initially rectilinear pattern of cracks evolves towards a more hexagonal pattern [12], although, due to the timescales involved, this has never been directly observed. The work reported here clearly demonstrates the plausibility of such an effect.

V. CONCLUSION

Mud-crack patterns found in nature often appear to have hexagonal order, and be composed of Y-junctions with $120^\circ$ angles. This is in contrast to the rectilinear craquehure patterns, dominated by T-junctions, that have more generally been studied experimentally. The results presented in this paper show that if a cracked clay layer is repeatedly wetted and dried, the crack pattern slowly evolves from a rectilinear pattern towards a hexagonal one. In a clay layer of a few mm thick, this happens in only 5 to 10 generations of drying and wetting. This relaxation is accompanied by all joint angles approaching $120^\circ$, and by a gradual motion of the crack vertices.

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